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MOS FIELD EFFECT POWER TRANSISTOR 2SK1852

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK1852 is N-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

• Low On-state Resistance

RDS(on) \leq 0.15 Ω (VGS = 10 V, ID = 5.0 A) RDS(on) \leq 0.2 Ω (VGS = 4 V, ID = 5.0 A)

- Low Ciss Ciss = 1 250 pF TYP.
- Built-in G-S Gate Protection Diode

QUALITY GRADE

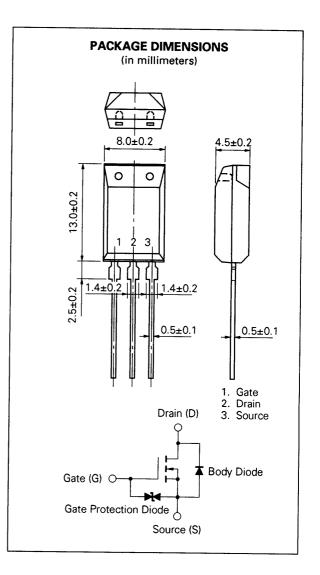
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS

Drain to Source Voltage	Voss	100	٧
Gate to Source Voltage	VGSS(AC)	±20	٧
Gate to Source Voltage	VGSS(DC)	+20, -10	٧
Drain Current (DC)	ID(DC)	±10	Α
Drain Current (pulse)	D(pulse)#	±40	Α
Total Power Dissipation (T	a = 25 °C) P	PT 1.8	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
* 514 < 40 5 5			

^{*} PW \leq 10 μ s, Duty Cycle \leq 1 %

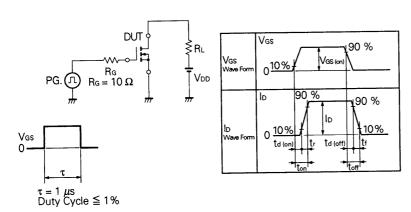




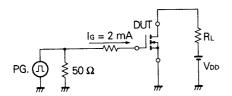
ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-state Resistance	RDS(on)		0.12	0.15	Ω	Vgs = 10 V, lp = 5 A	
Drain to Source On-state Resistance	Ros(on)		0.15	0.2	Ω	Vgs = 4 V, lp = 5 A	
Gate to Source Cutoff Voltage	Vgs(off)	1.0		2.5	V	V _{DS} = 10 V, I _D = 1 mA	
Forward Transfer Admittance	Yfs	5.5			s	V _{DS} = 10 V, I _D = 5 A	
Drain Leakage Current	loss			10	μΑ	V _{DS} = 100 V, V _{GS} = 0	
Gate to Source Leakage Current	Igss			±10	μА	Vgs = ±20 V, Vps = 0	
Input Capacitance	Ciss		1 250		pF	V _D s = 10 V	
Output Capacitance	Coss		320		pF	Vgs = 0 f = 1 MHz	
Reverse Transfer Capacitance	Crss		45		pF		
Turn-On Delay Time	td(on)		15		ns	$V_{GS(on)} = 10 \text{ V}$ $V_{DD} = 50 \text{ V}$ $I_{D} = 5 \text{ A, Rg} = 10 \Omega$ $R_{L} = 10 \Omega$	
Rise Time	tr		60		ns		
Turn-Off Delay Time	td(off)		130		ns		
Fall Time	tr		70		ns		
Total Gate Charge	QG		27		nC	V _{GS} = 10 V	
Gate to Source Charge	Qgs		4		nC	ID = 10 A	
Gate to Drain Charge	Qgp		6		nC	V _{DD} = 80 V	
Diode Forward Voltage	V _F (S-D)		1.0		V	Vgs = 0, lp = 10 A	
Reverse Recovery Time	trr		150		ns	$I_F = 10 \text{ A, Vgs} = 0$ $di/dt = 50 \text{ A/}\mu\text{s}$	
Reverse Recovery Charge	Qrr		300		nC		

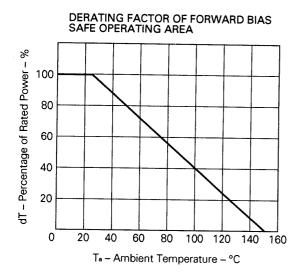
Test Circuit 1: Switching Time

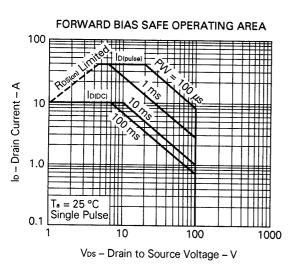


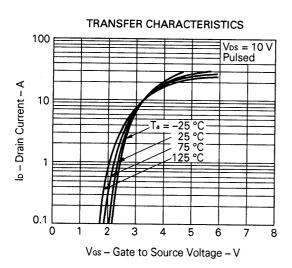
Test Circuit 2: Gate Charge

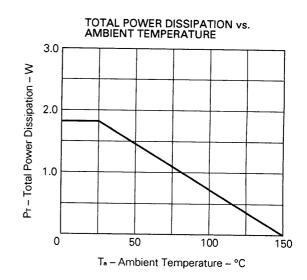


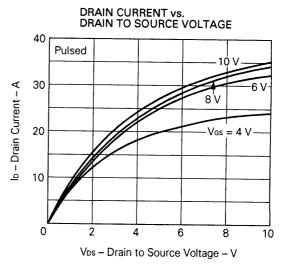
TYPICAL CHARACTERISTICS (Ta = 25 °C)

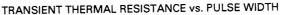


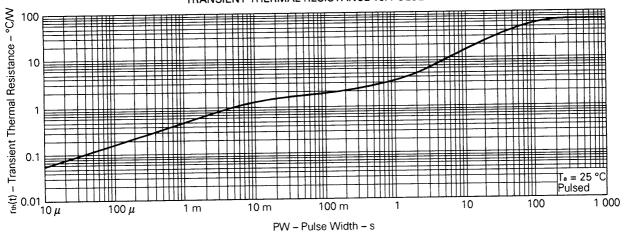




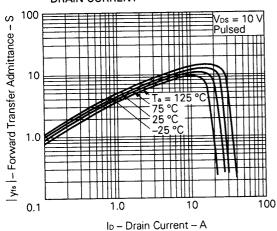




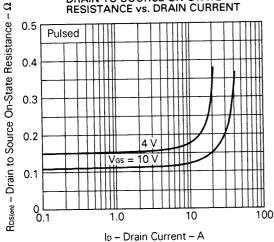




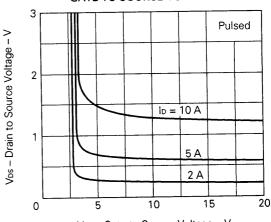
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

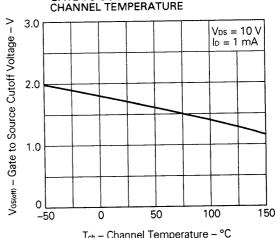


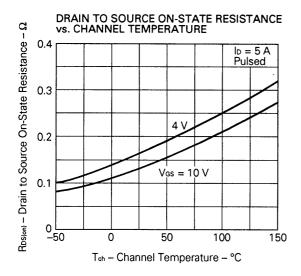
DRAIN TO SOURCE VOLTAGE vs. GATE TO SOURCE VOLTAGE

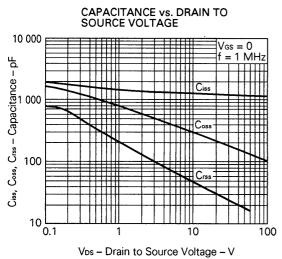


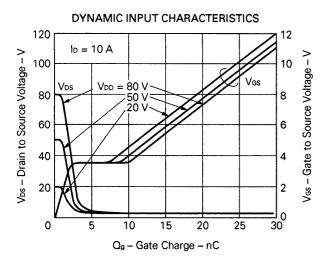
V_{GS} - Gate to Source Voltage - V

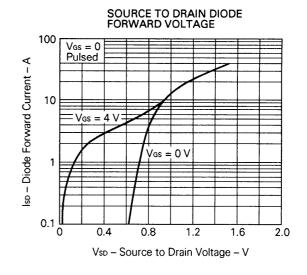
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

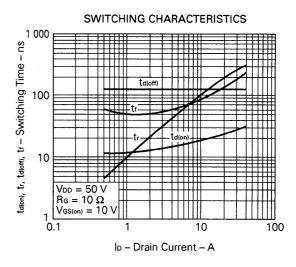


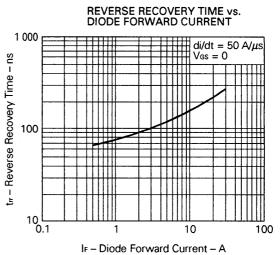












Reference

Application note name	No.	
Safe operating area of Power MOS FET.	TEA-1034	
Application circuit using Power MOS FET.	TEA-1035	
Quality control of NEC semiconductors devices.	TEI-1202	
Quality control guide of semiconductors devices.	MEI-1202	
Assembly manual of semiconductors devices.	IEI-1207	

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